



SUGGESTED PCB LAYOUT  
(COMPONENT SIDE)

- 1.MATERIAL:  
 HOUSING: PBT, BLACK, UL94V-0  
 CONTACTS: 0.35[0.014] THICK PHOSPHOR BRONZE PLATED WITH 100μ" MINIMUM THICK TIN IN SOLDER AREA. 15μ" MINIMUM GOLD IN LOCALIZED PLATE AREA. ENTIRE CONTACTS PLATED WITH 30μ" MINIMUM THICK NICKEL.  
 SHIELDED: 0.25[0.0098] THICK COPPER ZINC ALLOY PLATED WITH 30μ" MINIMUM THICK NICKEL.
- 2.JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F.
- 3.PART NUMBER: HRJM15-S1188-0-T-F2

				JOINT TECH ELECTRONIC IND. CO., LTD. JOY DAY INDUSTRIAL CO., LTD.	
		UNIT	SCALE	SHEET	TITLE:
		mm[inch]		1 of 1	
		DRAWN BY	APPROVED BY		
		董正一	謝瑞清		
		2002.02.01	2002.02.01		
		GENERAL TOLERANCE			
		X. X±0.25	ANGLE±		
		X. XX±0.15			
		X. XXX±0.05			
BO	NEW RELEASE	2005.12.25			DRAW NO. :
REV.	DESCRIPTION	DATE			HRJM15-S1188-0-T-F2
					REV. B0

RJ45, MODULAR JACK,  
1X1, W/O LED, 8P, 8C,  
SHIELDED, THRU-HOLE